

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT5126160

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the INVENTOR 3 AS "ABHAY DIXIT" INSTEAD OF "DIXIT ABHAY" previously recorded on Reel 042068 Frame 0502. Assignor(s) hereby confirms the INVENTOR 3 AS "ABHAY DIXIT" INSTEAD OF "DIXIT ABHAY".
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YING DUAN	01/26/2017
YASSER AHMED	01/26/2017
ABHAY DIXIT	01/27/2017
HARRY HUY DANG	04/18/2017
JING WU	01/26/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	QUALCOMM INCORPORATED
<b>Street Address:</b>	5775 MOREHOUSE DRIVE
<b>City:</b>	SAN DIEGO
<b>State/Country:</b>	CALIFORNIA
<b>Postal Code:</b>	92121-1714
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	15348290
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Email:</b>	qualcomm-pto@lozaip.com
<b>Correspondent Name:</b>	LOZA & LOZA LLP
<b>Address Line 1:</b>	305 NORTH SECOND AVENUE #127
<b>Address Line 4:</b>	UPLAND, CALIFORNIA 91786
<b>ATTORNEY DOCKET NUMBER:</b>	QCOM-3313US (164311)
<b>NAME OF SUBMITTER:</b>	JULIO LOZA
<b>SIGNATURE:</b>	/Julio Loza/
<b>DATE SIGNED:</b>	09/05/2018
<b>Total Attachments: 17</b>	

source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page1.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page2.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page3.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page4.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page5.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page6.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page7.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page8.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page9.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page10.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page11.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page12.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page13.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page14.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page15.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page16.tif  
source=164311\_Corrected\_Assignment\_as\_filed\_9-5-18#page17.tif

ASSIGNMENT

WHEREAS, WE,

1. Ying DUAN, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
2. Yasser AHMED, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
3. Abhay DIXIT, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
4. Harry Huy DANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
5. Jing WU, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to C-PHY HALF-RATE CLOCK AND DATA RECOVERY ADAPTIVE EDGE TRACKING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 15/348,290 filed November 10, 2016, Qualcomm Reference No. 164311, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications

thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at San Diego, on 01/26/2017  
LOCATION DATE

Ying Duan  
Ying DUAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Yasser AHMED

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
DIXIT Abhay

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Harry Huy DANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Jing WU

**ASSIGNMENT**

WHEREAS, WE,

1. **Ying DUAN**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
2. **Yasser AHMED**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
3. **Abhay DIXIT**, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
4. **Harry Huy DANG**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
5. **Jing WU**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to C-PHY HALF-RATE CLOCK AND DATA RECOVERY ADAPTIVE EDGE TRACKING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 15/348,290 filed November 10, 2016, Qualcomm Reference No. 164311, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications

thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Ying DUAN

Done at San Diego, CA, on 26 Jan 2017  
LOCATION DATE

\_\_\_\_\_  
Yasser AHMED

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
DIXIT Abhay

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Harry Huy DANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE

\_\_\_\_\_  
Jing WU



**ASSIGNMENT**

WHEREAS, WE,

1. **Ying DUAN**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
2. **Yasser AHMED**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
3. **Abhay DIXIT**, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
4. **Harry Huy DANG**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
5. **Jing WU**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to C-PHY HALF-RATE CLOCK AND DATA RECOVERY ADAPTIVE EDGE TRACKING (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 15/348,290 filed November 10, 2016, Qualcomm Reference No. 164311, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications

thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

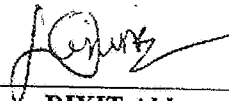
AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Ying DUAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Yasser AHMED

Done at SAN DIEGO, CA, on JAN 27, 2017  
LOCATION DATE  DIXIT Abhay

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Harry Huy DANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Jing WU

## ASSIGNMENT

WHEREAS, WE,

1. **Ying DUAN**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
2. **Yasser AHMED**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
3. **Abhay DIXIT**, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
4. **Harry Huy DANG**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
5. **Jing WU**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to C-PHY HALF-RATE CLOCK AND DATA RECOVERY ADAPTIVE EDGE TRACKING (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 15/348,290 filed November 10, 2016, Qualcomm Reference No. 164311, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications

thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Ying DUAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Yasser AHMED

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE DIXIT Abhay

Done at SAN DIEGO, on 4/18/2017  
LOCATION DATE Harry Huy DANG

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Jing WU

**ASSIGNMENT**

WHEREAS, WE,

1. **Ying DUAN**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
2. **Yasser AHMED**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
3. **Abhay DIXIT**, a citizen of India, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
4. **Harry Huy DANG**, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,
5. **Jing WU**, a citizen of China, having a mailing address located at 5775 Morehouse Drive San Diego California, 92121-1714 and a resident of San Diego, California,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to C-PHY HALF-RATE CLOCK AND DATA RECOVERY ADAPTIVE EDGE TRACKING (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 15/348,290 filed November 10, 2016, Qualcomm Reference No. 164311, and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications

thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;



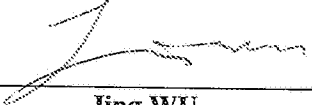
AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Ying DUAN

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Yasser AHMED

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE DIXIT Abhay

Done at \_\_\_\_\_, on \_\_\_\_\_  
LOCATION DATE Harry Huy DANG

Done at San Diego, on 1/26/2017  
LOCATION DATE   
Jing WU

**PATENT ASSIGNMENT COVER SHEET**

Electronic Version v1.1

Stylesheet Version v1.2

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT												
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT												
<b>CONVEYING PARTY DATA</b>													
<table><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>YING DUAN</td><td>01/26/2017</td></tr><tr><td>YASSER AHMED</td><td>01/26/2017</td></tr><tr><td>DIXIT ABHAY</td><td>01/27/2017</td></tr><tr><td>HARRY HUYNH DANG</td><td>04/18/2017</td></tr><tr><td>JING WU</td><td>01/26/2017</td></tr></tbody></table>	Name	Execution Date	YING DUAN	01/26/2017	YASSER AHMED	01/26/2017	DIXIT ABHAY	01/27/2017	HARRY HUYNH DANG	04/18/2017	JING WU	01/26/2017	
Name	Execution Date												
YING DUAN	01/26/2017												
YASSER AHMED	01/26/2017												
DIXIT ABHAY	01/27/2017												
HARRY HUYNH DANG	04/18/2017												
JING WU	01/26/2017												
<b>RECEIVING PARTY DATA</b>													
<b>Name:</b>	QUALCOMM INCORPORATED												
<b>Street Address:</b>	5775 MOREHOUSE DRIVE												
<b>City:</b>	SAN DIEGO												
<b>State/Country:</b>	CALIFORNIA												
<b>Postal Code:</b>	92121-1714												
<b>PROPERTY NUMBERS Total: 1</b>													
<table><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td><b>Application Number:</b></td><td>15348290</td></tr></tbody></table>	Property Type	Number	<b>Application Number:</b>	15348290									
Property Type	Number												
<b>Application Number:</b>	15348290												
<b>CORRESPONDENCE DATA</b>													
<b>Fax Number:</b>													
<b>Email:</b>	qualcomm-pto@lozaip.com												
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>													
<b>Correspondent Name:</b>	LOZA & LOZA LLP												
<b>Address Line 1:</b>	305 NORTH SECOND AVENUE #127												
<b>Address Line 4:</b>	UPLAND, CALIFORNIA 91786												
<b>ATTORNEY DOCKET NUMBER:</b>	QCOM-3313US (164311)												
<b>NAME OF SUBMITTER:</b>	JULIO LOZA												
<b>Signature:</b>	/Julio Loza/												

**PATENT****REEL: 047020 FRAME: 0922**

<b>Date:</b>	04/19/2017
<b>Total Attachments: 15</b> source=164311_Assignment_Signed_04182017#page1.tif source=164311_Assignment_Signed_04182017#page2.tif source=164311_Assignment_Signed_04182017#page3.tif source=164311_Assignment_Signed_04182017#page4.tif source=164311_Assignment_Signed_04182017#page5.tif source=164311_Assignment_Signed_04182017#page6.tif source=164311_Assignment_Signed_04182017#page7.tif source=164311_Assignment_Signed_04182017#page8.tif source=164311_Assignment_Signed_04182017#page9.tif source=164311_Assignment_Signed_04182017#page10.tif source=164311_Assignment_Signed_04182017#page11.tif source=164311_Assignment_Signed_04182017#page12.tif source=164311_Assignment_Signed_04182017#page13.tif source=164311_Assignment_Signed_04182017#page14.tif source=164311_Assignment_Signed_04182017#page15.tif	
<b>RECEIPT INFORMATION</b>  <b>EPAS ID:</b> PAT4375719 <b>Receipt Date:</b> 04/19/2017	